

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







SRDA70-4 RailClamp®

Low Capacitance TVS Diode Array

PROTECTION PRODUCTS

Description

RailClamps are surge rated diode arrays designed to protect high speed data interfaces. The SRDA70-4 has been specifically designed to protect sensitive components which are connected to data and transmission lines from over-voltages caused by electrostatic discharge (ESD), electrical fast transients (EFT), and lightning.

The unique design of the SRDA70-4 integrates eight surge rated, low capacitance steering diodes in a low profile SO-8 package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground. The SRDA70-4 may be used as a stand alone device or in conjunction with TVS diodes for enhanced protection.

The low capacitance array configuration allows the user to protect four high speed data or I/O lines. The low inductance construction minimizes voltage overshoot during high current surges.

Features

- ◆ Transient protection for high speed data lines to IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Lightning) 1kV, 24A (8/20µs)
- Array of surge rated diodes
- Protects four I/O lines
- ◆ Low capacitance for high-speed interfaces
- High surge capability
- ◆ Low forward voltage characteristics
- Solid-state silicon avalanche technology

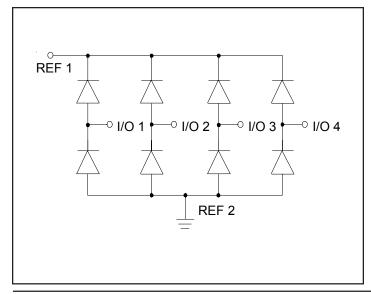
Mechanical Characteristics

- ◆ JEDEC SO-8 package
- UL 497B listed
- Molding compound flammability rating: UL 94V-0
- Marking: Part number, date code, logo
- Packaging: Tube or Tape and Reel per EIA 481.
- RoHS/WEEE Compliant

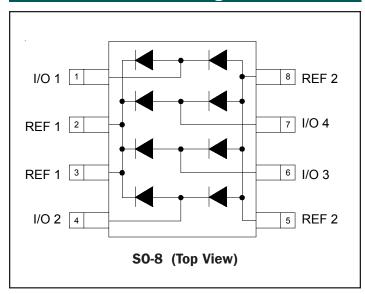
Applications

- Latch-Up Protection
- Microcontroller Input Protection
- Token Ring
- ◆ I²C Bus Protection
- Video Line Protection
- Set Top Box I/O
- LAN/WAN Equipment

Circuit Diagram



Schematic and PIN Configuration





Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Current (tp = 8/20µs)	l _{PP}	24	А
Rectifier Repetitive Peak Reverse Voltage	$V_{_{\mathrm{RRM}}}$	70	V
Thermal Resistance, Junction to Ambient	θ_{JA}	163	°C/W
Thermal Resistance, Junction to Case	θ_{JC}	38.8	°C/W
Lead Soldering Temperature	T _L	260 (10 sec.)	°C
Operating Temperature	T,	-55 to +125 °C	
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics

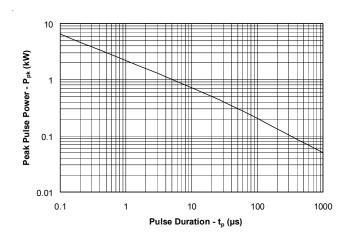
SRDA70-4

SKDATU-4						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Rectifier Repetitive Peak reverse Voltage	V_{RRM}				70	V
Reverse Breakdown Voltage	$V_{_{BR}}$	I _t = 50μΑ	85			V
Reverse Leakage Current	I _R	V _{RWM} = 70V, T=25°C			5	μΑ
Forward Voltage	V _F	$I_{pp} = 1A, t_{p} = 8/20 \mu s$			1.3	V
Forward Voltage	V _F	$I_{pp} = 10A, t_p = 8/20\mu s$			3.3	V
Junction Capacitance	C _j	Between I/O pins and Ground V _R = 0V, f = 1MHz			15	pF
		Between I/O pins V _R = OV, f = 1MHz		4		pF

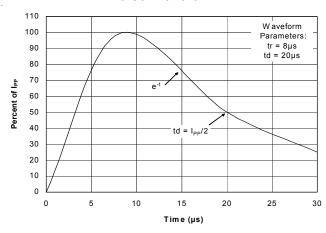


Typical Characteristics

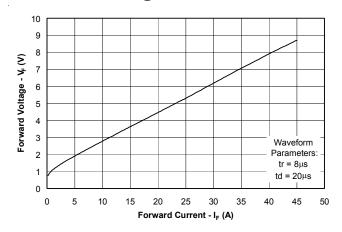
Non-Repetitive Peak Pulse Power vs. Pulse Time



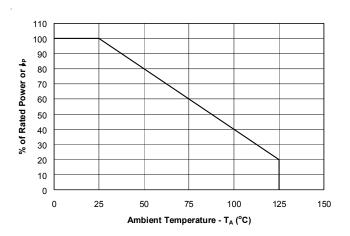
Pulse Waveform



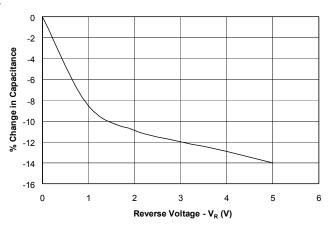
Foward Voltage vs. Forward Current



Power Derating Curve



Variation of Capacitance vs. Reverse Voltage





Applications Information

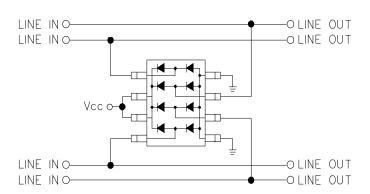
Device Connection Options for Protection of Four High-Speed Data Lines

The SRDA70-4 TVS is designed to protect four data lines from transient over-voltages by clamping them to a fixed reference. When the voltage on the protected line exceeds the reference voltage (plus diode $V_{\rm F}$) the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at pins 1, 4, 6 and 7. The negative reference (REF2) is connected at pins 5 and 8. These pins should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance.

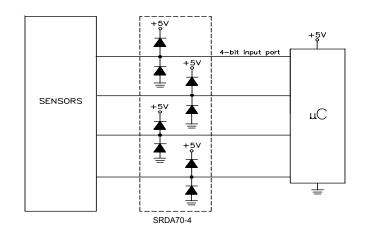
The positive reference (REF1) is connected at pins 2 and 3. The options for connecting the positive reference are as follows:

- 1. To protect data lines and the power line, connect pins 2 and 3 directly to the positive supply rail (V_{cc}). In this configuration the data lines are referenced to the supply voltage. An external TVS diode may be added between the supply rail and ground in order to prevent over-voltage on the supply rail.
- 2. The SRDA70-4 can be isolated from the power supply by adding a series resistor between pins 2 and 3 and V_{cc} . A value of $10 \mathrm{k}\Omega$ is recommended. The internal steering diodes remain biased, providing the advantage of lower capacitance.
- 3. In applications where no positive supply reference is available, or complete supply isolation is desired, an external TVS diode may be used as the reference. The steering diodes will begin to conduct when the voltage on the protected line exceeds the working voltage of the TVS (plus one diode drop).

I/O Protection



Microcontroller Protection

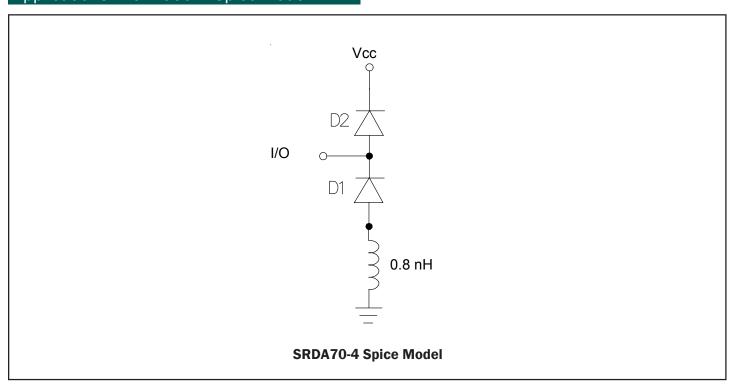


Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.



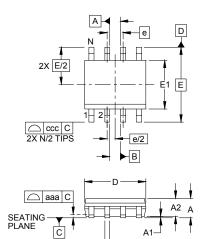
Applications Information - Spice Model

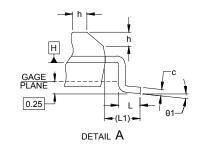


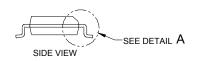
SRDA70-4 Spice Parameters					
Parameter	Unit	D1 (LCRD)	D2 (LCRD)		
IS	Amp	3.54E-14	1.46E-14		
BV	Volt	680	240		
۸٦	Volt	0.62	0.64		
RS	Ohm	0.330	0.124		
IBV	Amp	1E-3	1E-3		
C1O	Farad	5.2E-12	6.2E-12		
TT	sec	2.56E-9	2.56E-9		
М	1	0.058	0.058		
N	-	1.1	1.1		
EG	eV	1.11	1.11		



Outline Drawing - SO-8







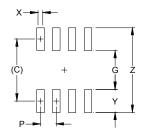
DIMENSIONS						
INCHES			MILLIMETERS			
MIN	NOM	MAX	MIN	NOM	MAX	
.053	-	.069	1.35	-	1.75	
.004	-	.010	0.10	-	0.25	
.049	-	.065	1.25	-	1.65	
.012	-	.020	0.31	-	0.51	
.007	-	.010	0.17	-	0.25	
.189	.193	.197	4.80	4.90	5.00	
.150	.154	.157	3.80	3.90	4.00	
.236 BSC			6.00 BSC			
.(050 BS	С	1.27 BSC			
.010	-	.020	0.25	-	0.50	
.016	.028	.041	0.40	0.72	1.04	
(.041)			(1.04)			
8			8			
0°	-	8°	0°	-	8°	
.004		0.10				
.010				0.25		
.008				0.20		
	MIN .053 .004 .049 .012 .007 .189 .150 .010	INCHE MIN NOM .053 004 049 012 007 189 .193 .150 .154 .236 BS .050 BS .010 016 .028 .041 .08 .09 004 .004 .004 .004 .0004 .0004 .0010	INCHES	INCHES MILL	INCHES MILLIMET MIN NOM MAX MIN NOM 0.53 - 0.69 1.35 - 0.004 - 0.10 0.10 - 0.49 - 0.65 1.25 - 0.12 - 0.20 0.31 - 0.007 - 0.10 0.17 - 1.89 .193 .197 4.80 4.90 .150 .154 .157 3.80 3.90 .236 BSC 6.00 BS 0.050 BSC 1.27 BS 0.10 - 0.20 0.25 - 0.016 0.028 0.41 0.40 0.72 (.041) (.041) (.104) 0.004 0.010 0.025 .004 0.010 0.025 .004 0.010 0.25	

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE -H-

- 3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 4. REFERENCE JEDEC STD MS-012, VARIATION AA.

Land Pattern - SO-8



DIMENSIONS					
DIM	INCHES	MILLIMETERS			
С	(.205)	(5.20)			
G	.118	3.00			
Р	.050	1.27			
Х	.024	0.60			
Υ	.087	2.20			
Z	.291	7.40			

NOTES:

- THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
 CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
 COMPANY'S MANUFACTURING GUIDELINES ARE MET.
- 2. REFERENCE IPC-SM-782A, RLP NO. 300A.



Ordering Information

Part Number	Lead Finish	Qty per Reel	Reel Size	
SRDA70-4.TB	SnPb	500	7 Inch	
SRDA70-4.TBT	Pb Free	500	7 Inch	
SRDA70-4	SnPb	95/Tube	N/A	
SRDA70-4.T	Pb Free	95/Tube	N/A	

Note: Lead-free devices are RoHS/WEEE Compliant

Contact Information

Semtech Corporation Protection Products Division 200 Flynn Road, Camarillo, CA 93012 Phone: (805)498-2111 FAX (805)498-3804